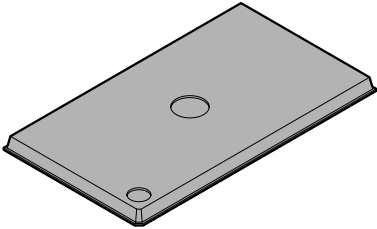
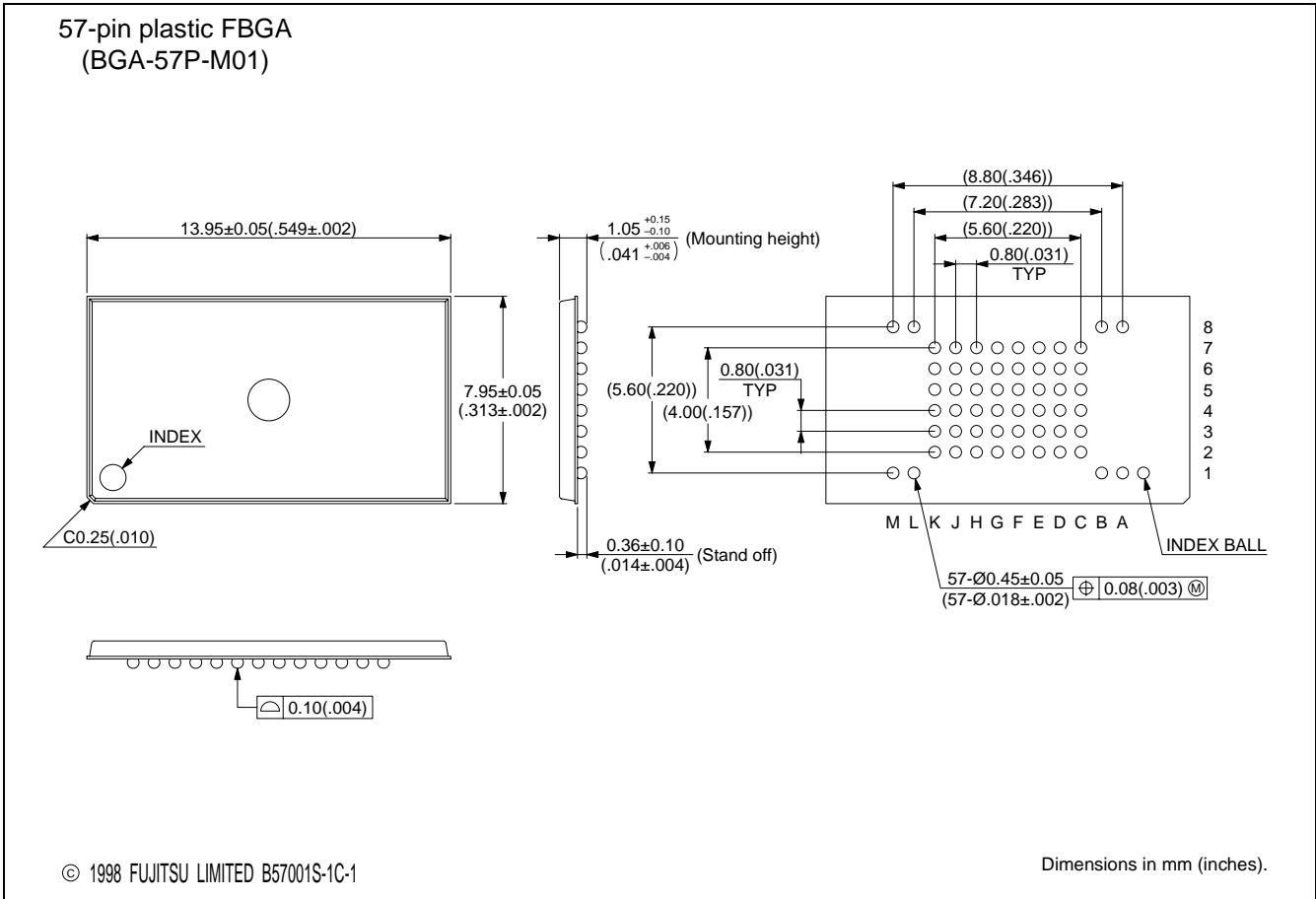


**BGA-57P-M01**

<p>57-pin plastic FBGA</p>  <p>(BGA-57P-M01)</p>	Ball pitch	0.80 mm
	Ball matrix	8 × 13
	Package width × package length	8.00 × 14.00 mm
	Sealing method	Plastic mold
	Mounting height	1.20 mm MAX
	Ball size	Ø 0.45



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